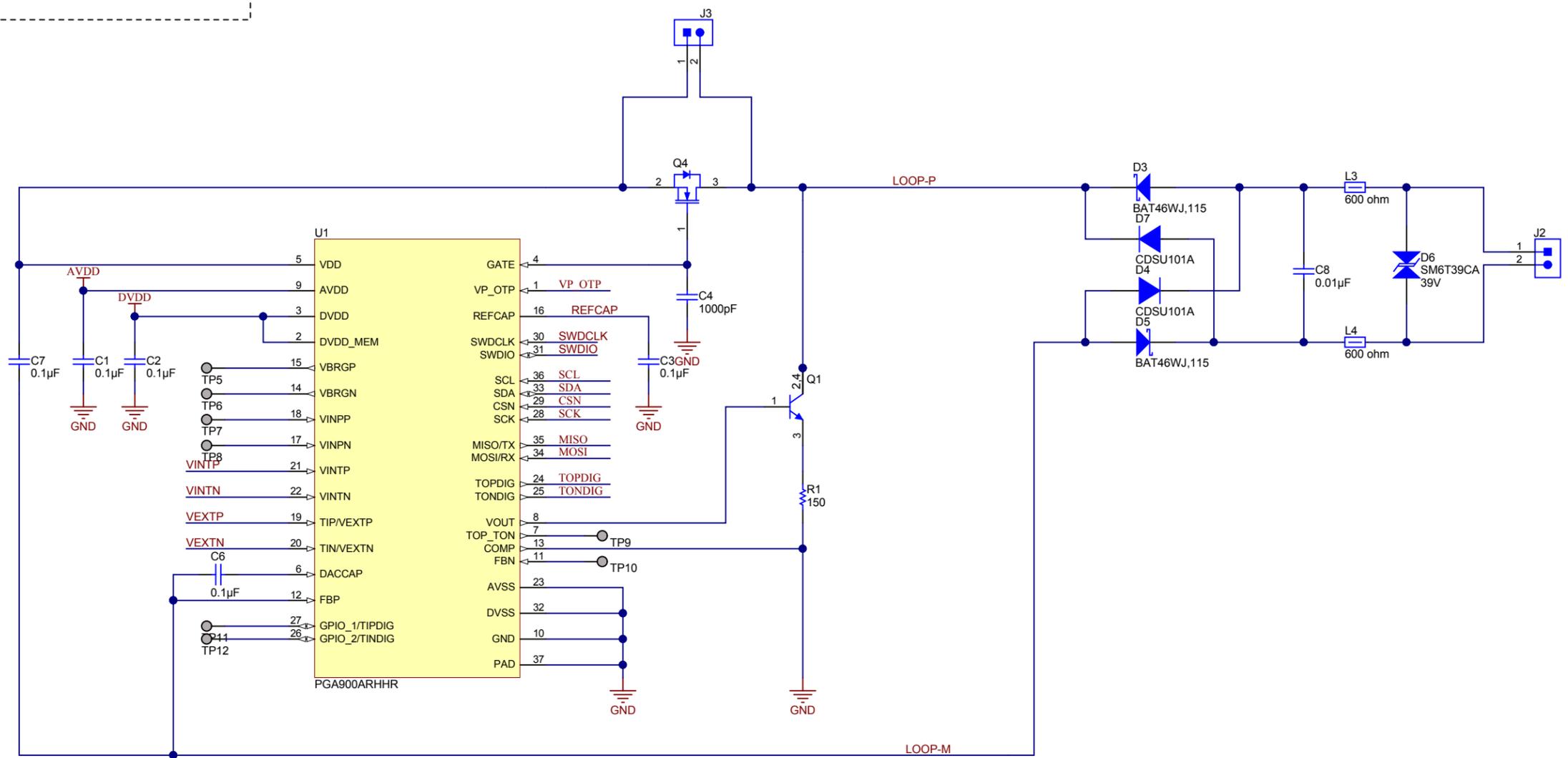
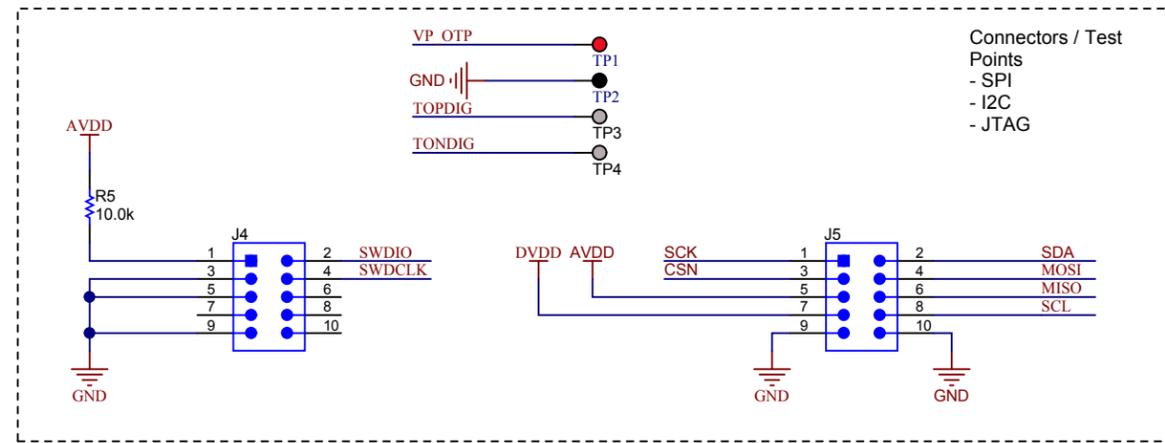
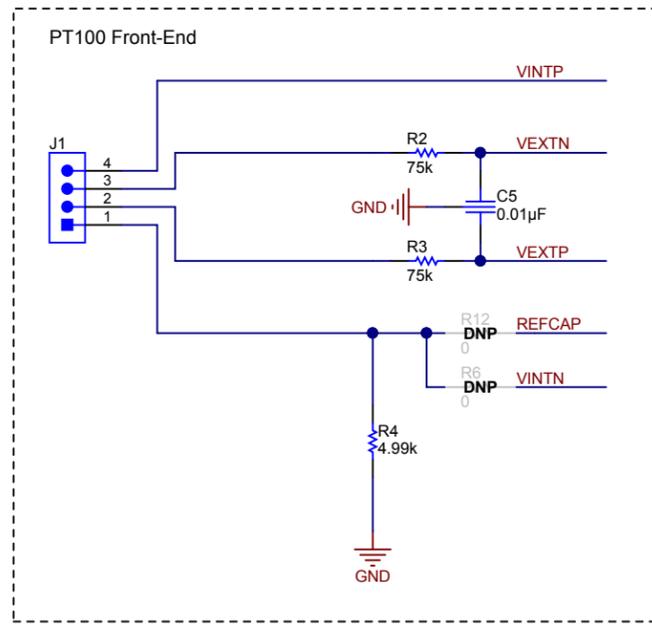


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TID #: TIDA-00851	Project Title: 4-20mA loop powered RTD transmitter	
Number: TIDA-00851	Rev: E1	Sheet Title: Block Diagram
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 3
Drawn By: AW	File: TIDA-00851_CoverSheet_SchDoc	Size: B
Engineer: AW	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



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TID #: TIDA-00851	Project Title: 4-20mA loop powered RTD transmitter	
Number: TIDA-00851	Rev: E1	Sheet Title: PGA900
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By: AW	File: TIDA-00851_BlankSheet_SchDoc	Size: B
Engineer: AW	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	

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DNP FID1 DNP FID2 DNP FID3

PCB Number: TIDA-00851  
PCB Rev: E1

PCB LOGO  
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PCB LOGO  
Pb-Free Symbol

PCB LOGO  
FCC disclaimer

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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TID #: TIDA-00851	Project Title: 4-20mA loop powered RTD transmitter		
Number: TIDA-00851	Rev: E1	Sheet Title: Hardware	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3	
Drawn By: AW	File: TIDA-00851_EVM_Hardware.SchDoc	Size: B	
Engineer: AW	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		

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